TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7MZ138FK

Low Voltage 3-to-8 Line Decoder with 5 V Tolerant Inputs and Outputs

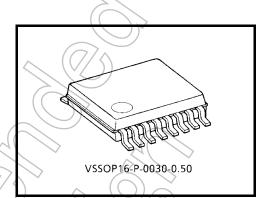
The TC7MZ138FK is a high performance CMOS 3-to-8 decoder. Designed for use in 3.3 V systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for inputs.

When the device is enabled, 3 binary select inputs (A, B and C) determine which one of the outputs  $(\overline{Y}0 \cdot \overline{Y}7)$  will go low.

When enable input G1 is held low or either  $\overline{G}2A$  or  $\overline{G}2B$  is held high, decoding function is inhibited and all outputs go high. G1,  $\overline{G}2A$ , and  $\overline{G}2B$  inputs are provided to ease cascade connection and for use as an address decoder for memory systems.

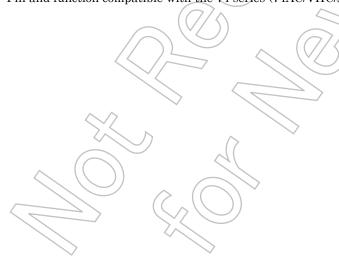
All inputs are equipped with protection circuits against static discharge.



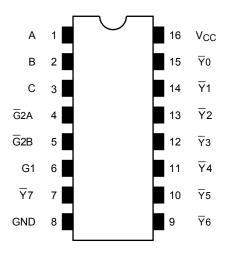
Weight: 0.02 g (typ.)

#### **Features**

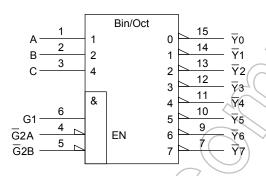
- Low voltage operation:  $V_{CC} = 2.0 \sim 3.6 \text{ V}$
- High speed operation:  $t_{pd} = 6.0 \text{ ns (max)} (V_{CC} = 3.0 \sim 3.6 \text{ V})$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: -500 mA
- Package: VSSOP (US16)
- Power down protection is provided on all inputs and outputs.
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 138 type.

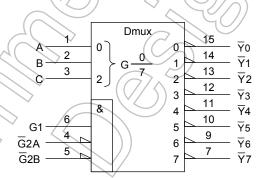


# Pin Assignment (top view)



# **IEC Logic Symbol**





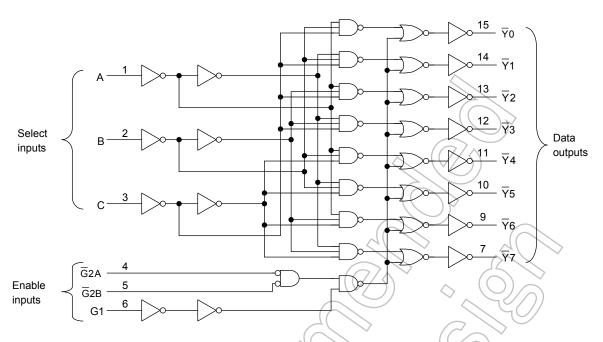
### **Truth Table**

							//		1	711				
	Inputs					Outputs								
	Enable			Select		// Y0	Y0 \(\overline{Y}_1\)		7x3		_ Y5	<u>-</u> Y6		Selected Output
G1	G <sub>2</sub> A	G <sub>2</sub> B	Ó	В	A	10		<u>Y</u> 2(	$\binom{13}{2}$	14	15	10	1 /	
L	Х	Х	X	X	Х	Н	Н	<u> </u>	)H	Н	Н	Н	Н	None
Х	Н	Х	Х	X	> x	Н	F	H	-ZH	Н	Н	Н	Н	None
Х	Х	¥	2x	Х	Х	Н	Н	$\mathcal{F}$	Н	Н	Н	Н	Н	None
Н	L	\ <u>\</u> (	)	<u>/</u> L	لــ	4	Н	H	Η	Η	Н	Η	Η	<del>\overline{Y}</del> 0
Н	٦		1	L	Н	14	L	Н	Н	Н	Н	Н	Н	Ÿ1
Н	4	7	ノ	Н	4	Ŧ	H	L	Н	Н	Н	Н	Н	<del>Y</del> 2
(H_	7	1	L	(H(	H	H)	Н	Н	L	Н	Н	Н	Н	<del>-</del> 73
Н	1/	)	Н	L	J/	F	Н	Н	Н	L	Н	Н	Н	<del>Y</del> 4
Н	7/	> L	Н	L	Ŧ	> H	Н	Н	Н	Н	L	Н	Н	<del>Y</del> 5
Н	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	<del>Y</del> 6
Н	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	<del>Y</del> 7

2

X: Don't care

#### **System Diagram**



## **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5~7.0	V
DC input voltage	VIN	-0.5~7.0	) v
DC output voltage	Vout	-0.5~7.0 (Note 2)	\ \ \
Do output voltage	V001	-0.5~V <sub>CC</sub> + 0.5 (Note 3)	V
Input diode current	(HK)	-50	mA
Output diode current	loк	±50 (Note 4)	mA
DC output current	Гоит	±50	mA
Power dissipation	P <sub>D</sub>	180	mW
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2:  $V_{CC} = 0 V$ 

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND, V_{OUT} > V_{CC}$ 

# **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0~3.6	V
Supply voltage	v CC	1.5~3.6 (Note 2)	V
Input voltage	V <sub>IN</sub>	0~5.5	V
Output voltage	Vout	0~5.5 (Note 3)	V
Output voltage	VOU1	0~V <sub>CC</sub> (Note 4)	V
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±24 (Note 5)	mA (
Output current	IOH/IOL	±12 (Note 6)	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Operating temperature	T <sub>opr</sub>	-40~85	~e
Input rise and fall time	dt/dv	0~10 (Note 7)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3:  $V_{CC} = 0 V$ 

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \sim 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \sim 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8 \sim 2.0 \text{ V}, V_{CC} = 3.0 \text{ V}$ 

#### **Electrical Characteristics**

# DC Characteristics ( $Ta = -40 \sim 85$ °C)

Characte	eristics	Symbol	Test Condition		V (V)	Min	Max	Unit	
	High level	VIH	$\mathcal{L}$		V <sub>CC</sub> (V)	2.0	_	.,	
Input voltage	Low level	VIL			2.7~3.6	_	0.8	V	
				I <sub>OH</sub> = -100 μA	2.7~3.6	V <sub>CC</sub> - 0.2	_	_	
	High level	V <sub>OH</sub>	VIN = VIH or VIL	I <sub>OH</sub> = -12 mA	2.7	2.2			
	2/	)	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -18 mA	3.0	2.4	_	.	
Output voltage				I <sub>OH</sub> = -24 mA	3.0	2.2	_		
		Vol		I <sub>OL</sub> = 100 μA	2.7~3.6	_	0.2		
	Low level			I <sub>OL</sub> = 12 mA	2.7	_	0.4		
	Low level			I <sub>OL</sub> = 16 mA	3.0	_	0.4		
				I <sub>OL</sub> = 24 mA	3.0	_	0.55		
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0~5.5 V		2.7~3.6	_	±5.0	μА	
Power off leakage current		I <sub>OFF</sub>	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V	0	_	10.0	μА		
Quiescent supply current		laa	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7~3.6	_	10.0		
Quiescent suppry	y current	Icc	V <sub>IN</sub> = 3.6~5.5 V	2.7~3.6	_	±10.0	μΑ		
Increase in I <sub>CC</sub> p	er input	Δl <sub>CC</sub>	$V_{IH} = V_{CC} - 0.6 V$		2.7~3.6	_	500		

### AC Characteristics ( $Ta = -40 \sim 85$ °C)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7	_	7.0	ns
(A, B, C- $\overline{Y}$ )	t <sub>pHL</sub>	rigure 1, rigure 2	$3.3 \pm 0.3$	1.5	6.0	115
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7		8.0	ns
(G1- $\overline{Y}$ )	t <sub>pHL</sub>	Figure 1, Figure 2	3.3 ± 0.3	1.5	7.0	115
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7	)  -	7.0	ns
( <del>G</del> 2 - <del>Y</del> )	t <sub>pHL</sub>	rigure 1, rigure 2	$3.3 \pm 0.3$	1.5	6.0	115
Output to output skew	t <sub>osLH</sub>	(Note)	2.1		_	ns
Output to output skew	t <sub>osHL</sub>	(Note)	$3.3 \pm 0.3$		1.0	110

Note: This parameter is guaranteed by design.

 $(t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|)$ 

Dynamic Switching Characteristics (Ta = 25°C, Input:  $t_r = t_f = 2.5$  ns,  $C_L = 50$  pF,  $R_L = 500$   $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic $V_{OL}$	$V_{OLP}$	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	8.0	V
Quiet output minimum dynamic $V_{OL}$	V <sub>OLV</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	8.0	٧

# Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	CIN		3.3	7	pF
Output capacitance	Cout		0	8	pF
Power dissipation capacitance	CPD	f <sub>IN</sub> = 10 MHz (Note)	3.3	25	pF

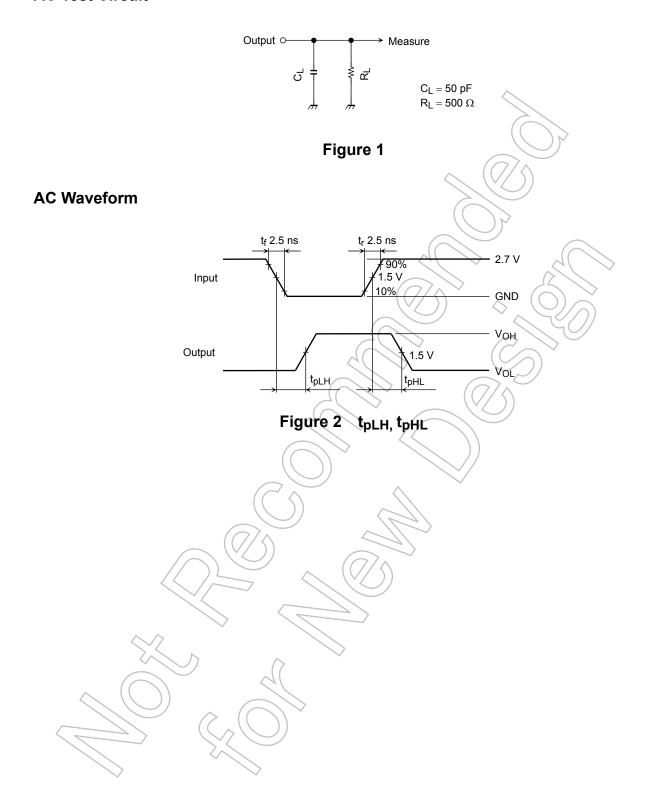
Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

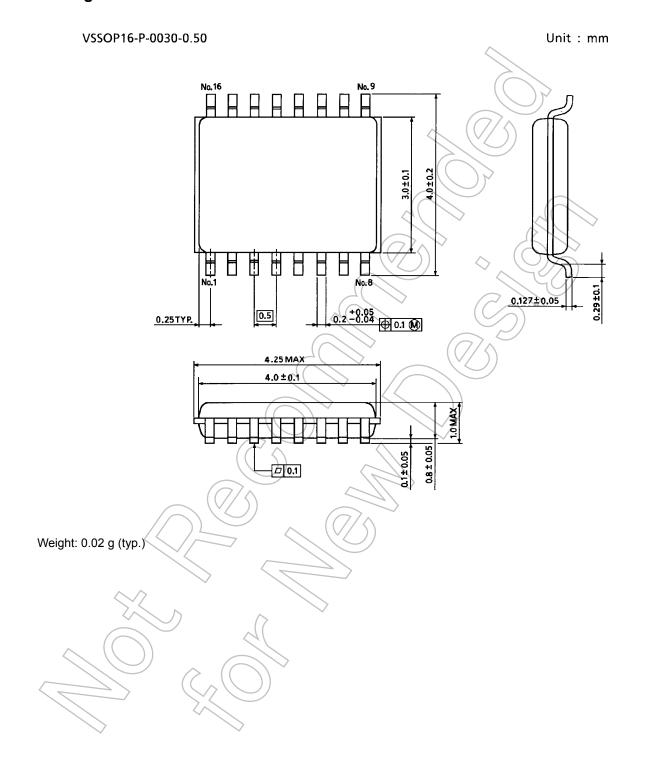
 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 



### **AC Test Circuit**



# **Package Dimensions**



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